Special Issue

Novel Functional Materials and Techniques for 3D-Microfabrication

Message from the Guest Editor

It is my pleasure to invite you to contribute to the Special Issue of Micromachines focused entitled "Novel Functional Materials and Techniques for 3D-Microfabrication". The aim of this Special Issue is to bring together several prominent experts in the field of 3D-microfabrication to cover their latest research and share their views on the challenges and opportunities related to this field. Potential topics include, but are not limited to, the development of responsive materials and formulations, the design of novel functional architectures, bioinspired solutions, innovative manufacturing approaches, the development of new fabrication techniques, smart sensing devices, MEMS, and fundamental aspects of 3D-microfabrication. In the light of your interesting work in this area, we are delighted to invite you and your colleagues to submit a manuscript in the form of a research article, communication, or review paper. The editorial team at Micromachines and I hope that you accept this invitation. We look forward to receiving your positive response and your contribution.

Guest Editor

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Deadline for manuscript submissions

closed (29 February 2024)



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About the Journal

Message from the Editor-in-Chief

You are invited to contribute research articles or comprehensive reviews for consideration and publication in *Micromachines* (ISSN 2072-666X). *Micromachines* is published in the open access format. Research articles, reviews and other contents are released on the internet immediately after acceptance. The scientific community and the general public have unlimited free access to the content as soon as it is published. As an open access journal, *Micromachines* is supported by the authors or their institutes by payment of article processing charges (APC) for accepted papers. We are pleased to welcome you as our authors.

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